

設備名稱：恆溫乾果機

型號（型式）：

Equipment name

Type designation (Type)

HFD-25F1 HFD-25F2 HFD-25F3 HFD-25F4 HFD-25F5
25F1-HFD 25F2-HFD 25F3-HFD 25F4-HFD 25F5-HFD

| 單元 Unit | 限用物質及其化學符號 Restricted substances and its chemical symbols | | | | | |
|---------|--|----------------------|----------------------|---|--|--|
| | 鉛 Lead (Pb) | 汞 Mercury (Hg) | 鎘 Cadmium (Cd) | 六價鉻 Hexavalent chromium (Cr+6) | 多溴聯苯 Polybrominated biphenyls (PBB) | 多溴二苯醚 Polybrominated diphenyl ethers (PBDE) |
| 承物架AS | ○ | ○ | ○ | ○ | ○ | ○ |
| 底座ABS | ○ | ○ | ○ | ○ | ○ | ○ |
| 面貼PVC | ○ | ○ | ○ | ○ | ○ | ○ |
| 罩極電機 | ○ | ○ | ○ | ○ | ○ | ○ |
| 電源線 | ○ | ○ | ○ | ○ | ○ | ○ |
| 五金件 | ○ | ○ | ○ | ○ | ○ | ○ |

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。
Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。
Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。
Note 3: The “-” indicates that the restricted substance corresponds to the exemption.